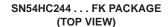
SCLS130D - DECEMBER 1982 - REVISED AUGUST 2003

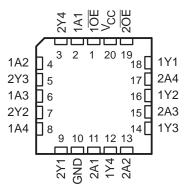
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Outputs Drive Up To 15 LSTTL Loads
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers

SN54HC244 . . . J OR W PACKAGE SN74HC244 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)

|               |    |                | _               |
|---------------|----|----------------|-----------------|
| 1 <u>OE</u> [ | 1  | $\bigcup_{20}$ | V <sub>CC</sub> |
| 1A1 [         | 2  | 19             |                 |
| 2Y4 [         | 3  | 18             | ] 1Y1           |
| 1A2 [         | 4  | 17             |                 |
| 2Y3 [         |    | 16             | _               |
| 1A3 [         | 6  | 15             | ] 2A3           |
| 2Y2 [         | 7  | 14             | ] 1Y3           |
| 1A4 [         | 8  | 13             |                 |
| 2Y1 [         | 9  | 12             | ] 1Y4           |
| GND [         | 10 | 11             | 2A1             |

- Low Power Consumption, 80-μA Max I<sub>CC</sub>
- Typical t<sub>pd</sub> = 11 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max





#### description/ordering information

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'HC244 devices are organized as two 4-bit buffers/drivers with separate output-enable  $(\overline{OE})$  inputs. When  $\overline{OE}$  is low, the device passes noninverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

#### ORDERING INFORMATION

| TA             | PACKAG     | GE†          | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |  |
|----------------|------------|--------------|--------------------------|---------------------|--|
|                | PDIP – N   | Tube of 20   | SN74HC244N               | SN74HC244N          |  |
|                | SOIC - DW  | Tube of 25   | SN74HC244DW              | HC244               |  |
|                | 301C - DVV | Reel of 2000 | SN74HC244DWR             | ПС244               |  |
| -40°C to 85°C  | SOP - NS   | Reel of 2000 | SN74HC244NSR             | HC244               |  |
| -40 C to 65 C  | SSOP – DB  | Reel of 2000 | SN74HC244DBR             | HC244               |  |
|                |            | Tube of 70   | SN74HC244PW              |                     |  |
|                | TSSOP – PW | Reel of 2000 | SN74HC244PWR             | HC244               |  |
|                |            | Reel of 250  | SN74HC244PWT             |                     |  |
|                | CDIP – J   | Tube of 20   | SNJ54HC244J              | SNJ54HC244J         |  |
| −55°C to 125°C | CFP – W    | Tube of 85   | SNJ54HC244W              | SNJ54HC244W         |  |
|                | LCCC – FK  | Tube of 55   | SNJ54HC244FK             | SNJ54HC244FK        |  |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

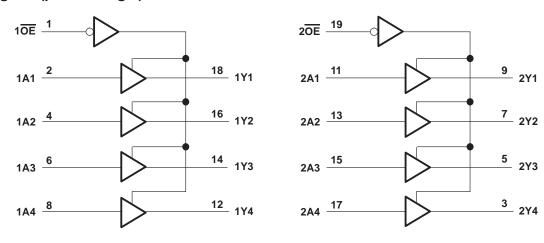


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# FUNCTION TABLE (each buffer/driver)

| INP | JTS | OUTPUT |
|-----|-----|--------|
| ŌĒ  | Α   | Υ      |
| L   | Н   | Н      |
| L   | L   | L      |
| Н   | Χ   | Z      |

#### logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V <sub>CC</sub>   |              | 0.5 V to 7 V   |
|---|--------------|----------------|
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see                              | e Note 1)    | ±20 mA         |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> ) | (see Note 1) | ±20 mA         |
| Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$ .                                  |              | ±35 mA         |
| Continuous current through V <sub>CC</sub> or GND   |              | ±70 mA         |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): [  | DB package   | 70°C/W         |
|   | DW package   | 58°C/W         |
| 1   | N package    | 69°C/W         |
| 1   | NS package   | 60°C/W         |
| F   | PW package   | 83°C/W         |
| Storage temperature range, T <sub>stq</sub>   |              | -65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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## recommended operating conditions (see Note 3)

|       |  |                          | SI   | 154HC24 | 14   | SN74HC244 |     |      | UNIT |  |
|-------|--|--------------------------|------|---------|------|-----------|-----|------|------|--|
|       |  |                          | MIN  | NOM     | MAX  | MIN       | NOM | MAX  | UNII |  |
| Vcc   | Supply voltage                           |                          | 2    | 5       | 6    | 2         | 5   | 6    | V    |  |
|       |  | V <sub>CC</sub> = 2 V    | 1.5  |         |      | 1.5       |     |      |      |  |
| VIH   | V <sub>IH</sub> High-level input voltage | $V_{CC} = 4.5 \text{ V}$ | 3.15 |         |      | 3.15      |     |      | V    |  |
|       |  | VCC = 6 V                | 4.2  |         |      | 4.2       |     |      |      |  |
|       |  | V <sub>CC</sub> = 2 V    |      |         | 0.5  |           |     | 0.5  |      |  |
| VIL   | Low-level input voltage                  | V <sub>CC</sub> = 4.5 V  |      |         | 1.35 |           |     | 1.35 | V    |  |
|       |  | VCC = 6 V                |      |         | 1.8  |           |     | 1.8  |      |  |
| VI    | Input voltage                            |                          | 0    |         | VCC  | 0         |     | VCC  | V    |  |
| Vo    | Output voltage                           |                          | 0    |         | VCC  | 0         |     | VCC  | V    |  |
|       |  | V <sub>CC</sub> = 2 V    |      |         | 1000 |           |     | 1000 |      |  |
| Δt/Δν | Input transition rise/fall time          | V <sub>CC</sub> = 4.5 V  |      |         | 500  |           |     | 500  | ns   |  |
|       |  | V <sub>CC</sub> = 6 V    |      |         | 400  |           |     | 400  |      |  |
| TA    | Operating free-air temperature           |                          | -55  |         | 125  | -40       |     | 85   | °C   |  |

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST CONDITIONS            |                            | Vaa        | Т    | A = 25°C | ;    | SN54H | IC244 | SN74H | C244  | UNIT |
|-----------|----------------------------|----------------------------|------------|------|----------|------|-------|-------|-------|-------|------|
| PARAMETER | 1251 CC                    | CNDITIONS                  | VCC        | MIN  | TYP      | MAX  | MIN   | MAX   | MIN   | MAX   | ONIT |
|           |                            |                            | 2 V        | 1.9  | 1.998    |      | 1.9   |       | 1.9   |       |      |
|           |                            | $I_{OH} = -20  \mu A$      | 4.5 V      | 4.4  | 4.499    |      | 4.4   |       | 4.4   |       |      |
| Voн       | VI = VIH or VIL            |                            | 6 V        | 5.9  | 5.999    |      | 5.9   |       | 5.9   |       | V    |
|           |                            | $I_{OH} = -6 \text{ mA}$   | 4.5 V      | 3.98 | 4.3      |      | 3.7   |       | 3.84  |       |      |
|           |                            | $I_{OH} = -7.8 \text{ mA}$ | 6 V        | 5.48 | 5.8      |      | 5.2   |       | 5.34  |       |      |
|           |                            |                            | 2 V        |      | 0.002    | 0.1  |       | 0.1   |       | 0.1   |      |
|           |                            | I <sub>OL</sub> = 20 μA    | 4.5 V      |      | 0.001    | 0.1  |       | 0.1   |       | 0.1   |      |
| VOL       | $V_I = V_{IH}$ or $V_{IL}$ |                            | 6 V        |      | 0.001    | 0.1  |       | 0.1   |       | 0.1   | V    |
|           |                            | $I_{OL} = 6 \text{ mA}$    | 4.5 V      |      | 0.17     | 0.26 |       | 0.4   |       | 0.33  |      |
|           |                            | $I_{OL} = 7.8 \text{ mA}$  | 6 V        |      | 0.15     | 0.26 |       | 0.4   |       | 0.33  |      |
| lį        | $V_I = V_{CC}$ or 0        |                            | 6 V        |      | ±0.1     | ±100 |       | ±1000 |       | ±1000 | nA   |
| loz       | $V_O = V_{CC}$ or 0,       | $V_I = V_{IH}$ or $V_{IL}$ | 6 V        |      | ±0.01    | ±0.5 |       | ±10   |       | ±5    | μΑ   |
| Icc       | $V_I = V_{CC}$ or 0,       | IO = 0                     | 6 V        |      |          | 8    |       | 160   |       | 80    | μΑ   |
| Ci        |                            |                            | 2 V to 6 V |      | 3        | 10   |       | 10    |       | 10    | pF   |

## SN54HC244, SN74HC244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

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# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER         | FROM    | то       | Vaa   | T   | λ = 25°C | ;   | SN54H | C244 | SN74H | IC244 | UNIT |
|-------------------|---------|----------|-------|-----|----------|-----|-------|------|-------|-------|------|
| PARAMETER         | (INPUT) | (OUTPUT) | VCC   | MIN | TYP      | MAX | MIN   | MAX  | MIN   | MAX   | UNII |
|                   |         |          | 2 V   |     | 40       | 115 |       | 170  |       | 145   |      |
| t <sub>pd</sub> A | Υ       | 4.5 V    |       | 13  | 23       |     | 34    |      | 29    | ns    |      |
|                   |         |          | 6 V   |     | 11       | 20  |       | 29   |       | 25    |      |
|                   |         | Y        | 2 V   |     | 75       | 150 |       | 225  |       | 190   |      |
| <sup>t</sup> en   | ŌĒ      |          | 4.5 V |     | 15       | 30  |       | 45   |       | 38    | ns   |
|                   |         |          | 6 V   |     | 13       | 26  |       | 38   |       | 32    |      |
|                   |         | Y        | 2 V   |     | 75       | 150 |       | 225  |       | 190   |      |
| <sup>t</sup> dis  | ŌĒ      |          | 4.5 V |     | 15       | 30  |       | 45   |       | 38    | ns   |
|                   |         |          | 6 V   |     | 13       | 26  |       | 38   |       | 32    |      |
|                   |         | Y        | 2 V   |     | 28       | 60  |       | 90   |       | 75    | ns   |
| t <sub>t</sub>    |         |          | 4.5 V |     | 8        | 12  |       | 18   |       | 15    |      |
|                   |         |          | 6 V   |     | 6        | 10  |       | 15   |       | 13    |      |

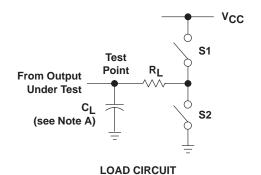
# switching characteristics over recommended operating free-air temperature range, $C_L$ = 150 pF (unless otherwise noted) (see Figure 1)

| DADAMETED       | PARAMETER FROM TO V |          | Vaa   | T,  | λ = 25°C | ;   | SN54F | IC244 | SN74H | IC244 | UNIT |
|-----------------|---------------------|----------|-------|-----|----------|-----|-------|-------|-------|-------|------|
| PARAMETER       | (INPUT)             | (OUTPUT) | VCC   | MIN | TYP      | MAX | MIN   | MAX   | MIN   | MAX   | UNII |
|                 |                     |          | 2 V   |     | 56       | 165 |       | 245   |       | 210   |      |
| <sup>t</sup> pd | Α                   | Y        | 4.5 V |     | 18       | 33  |       | 49    |       | 42    | ns   |
| · l             |                     |          | 6 V   |     | 15       | 28  |       | 42    |       | 35    |      |
|                 |                     | Υ        | 2 V   |     | 100      | 200 |       | 300   |       | 250   | ns   |
| t <sub>en</sub> | ŌĒ                  |          | 4.5 V |     | 20       | 40  |       | 60    |       | 50    |      |
|                 |                     |          | 6 V   |     | 17       | 34  |       | 51    |       | 43    |      |
|                 |                     |          | 2 V   |     | 45       | 210 |       | 315   |       | 265   |      |
| t <sub>t</sub>  |                     | Υ        | 4.5 V |     | 17       | 42  |       | 63    |       | 53    | ns   |
|                 |                     |          | 6 V   |     | 13       | 36  |       | 53    |       | 45    |      |

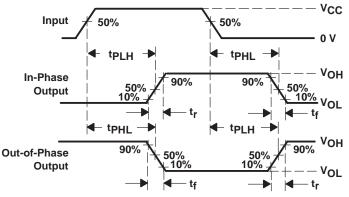
## operating characteristics, $T_A = 25^{\circ}C$

|                 | PARAMETER                                       | TEST CONDITIONS | TYP | UNIT |
|-----------------|---|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance per buffer/driver | No load         | 35  | pF   |

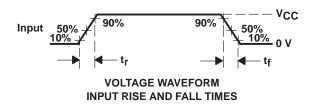
#### PARAMETER MEASUREMENT INFORMATION

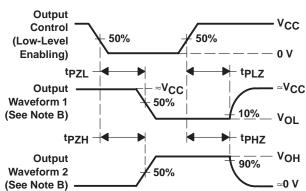


| PARAI                             | METER | RL             | CL                    | S1     | S2     |  |
|-----------------------------------|-------|----------------|-----------------------|--------|--------|--|
| t                                 | tPZH  | 1 kO           | 50 pF                 | Open   | Closed |  |
| ten                               | tPZL  | 1 kΩ or 150 pF |                       | Closed | Open   |  |
| 4                                 | tPHZ  | <b>1 k</b> Ω   | 50 pF                 | Open   | Closed |  |
| <sup>t</sup> dis                  | tPLZ  | 1 K22          | 30 pr                 | Closed | Open   |  |
| t <sub>pd</sub> or t <sub>t</sub> |       | _              | 50 pF<br>or<br>150 pF | Open   | Open   |  |



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES





VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

- NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \Omega$ ,  $t_r = 6$  ns.
  - D. The outputs are measured one at a time with one input transition per measurement.
  - E. tpLZ and tpHZ are the same as tdis.
  - F. tpzL and tpzH are the same as ten.
  - G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms





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## **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| 5962-8409601VRA  | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| 5962-8409601VSA  | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                     | Call TI          | N / A for Pkg Type           |
| 84096012A        | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 8409601RA        | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| 8409601SA        | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                     | Call TI          | N / A for Pkg Type           |
| JM38510/65705B2A | ACTIVE                | LCCC            | FK                 | 20   | 1              | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| JM38510/65705BRA | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| JM38510/65705BSA | ACTIVE                | CFP             | W                  | 20   | 1              | TBD                     | Call TI          | N / A for Pkg Type           |
| SN54HC244J       | ACTIVE                | CDIP            | J                  | 20   | 1              | TBD                     | A42              | N / A for Pkg Type           |
| SN74HC244ADBLE   | OBSOLETE              | SSOP            | DB                 | 20   |                | TBD                     | Call TI          | Call TI                      |
| SN74HC244APWLE   | OBSOLETE              | TSSOP           | PW                 | 20   |                | TBD                     | Call TI          | Call TI                      |
| SN74HC244DBLE    | OBSOLETE              | SSOP            | DB                 | 20   |                | TBD                     | Call TI          | Call TI                      |
| SN74HC244DBR     | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DBRE4   | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DBRG4   | ACTIVE                | SSOP            | DB                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DW      | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DWE4    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DWG4    | ACTIVE                | SOIC            | DW                 | 20   | 25             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DWR     | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DWRE4   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244DWRG4   | ACTIVE                | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244N       | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)       | CU NIPDAU        | N / A for Pkg Type           |
| SN74HC244N3      | OBSOLETE              | PDIP            | N                  | 20   |                | TBD                     | Call TI          | Call TI                      |
| SN74HC244NE4     | ACTIVE                | PDIP            | N                  | 20   | 20             | Pb-Free<br>(RoHS)       | CU NIPDAU        | N / A for Pkg Type           |
| SN74HC244NSR     | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244NSRE4   | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244NSRG4   | ACTIVE                | SO              | NS                 | 20   | 2000           | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PW      | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWE4    | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWG4    | ACTIVE                | TSSOP           | PW                 | 20   | 70             | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

#### PACKAGE OPTION ADDENDUM

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| Orderable Device  | Status (1) | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | e Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|-------------------|------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74HC244PWLE     | OBSOLETE   | TSSOP           | PW                 | 20   |                | TBD                       | Call TI          | Call TI                      |
| SN74HC244PWR      | ACTIVE     | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWRE4    | ACTIVE     | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWRG4    | ACTIVE     | TSSOP           | PW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWT      | ACTIVE     | TSSOP           | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWTE4    | ACTIVE     | TSSOP           | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244PWTG4    | ACTIVE     | TSSOP           | PW                 | 20   | 250            | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC244QDWRG4Q1 | ACTIVE     | SOIC            | DW                 | 20   | 2000           | Green (RoHS & no Sb/Br)   | CU NIPDAU        | Level-1-260C-UNLIM           |
| SNJ54HC244FK      | ACTIVE     | LCCC            | FK                 | 20   | 1              | TBD                       | POST-PLATE       | N / A for Pkg Type           |
| SNJ54HC244J       | ACTIVE     | CDIP            | J                  | 20   | 1              | TBD                       | A42              | N / A for Pkg Type           |
| SNJ54HC244W       | ACTIVE     | CFP             | W                  | 20   | 1              | TBD                       | Call TI          | N / A for Pkg Type           |

<sup>&</sup>lt;sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF SN54HC244, SN54HC244-SP, SN74HC244:

Automotive: SN74HC244-Q1

Enhanced Product: SN74HC244-EP



## **PACKAGE OPTION ADDENDUM**

15-Oct-2009 www.ti.com

NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
   Enhanced Product Supports Defense, Aerospace and Medical Applications





.com 10-Nov-2008

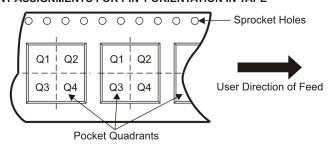
#### TAPE AND REEL INFORMATION





|    | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device       |       | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|--------------|-------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74HC244DBR | SSOP  | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2     | 7.5     | 2.5     | 12.0       | 16.0      | Q1               |
| SN74HC244DWR | SOIC  | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.1    | 2.65    | 12.0       | 24.0      | Q1               |
| SN74HC244DWR | SOIC  | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.8    | 13.0    | 2.7     | 12.0       | 24.0      | Q1               |
| SN74HC244NSR | SO    | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.2     | 13.0    | 2.5     | 12.0       | 24.0      | Q1               |
| SN74HC244PWR | TSSOP | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95    | 7.1     | 1.6     | 8.0        | 16.0      | Q1               |





\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HC244DBR | SSOP         | DB              | 20   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74HC244DWR | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74HC244DWR | SOIC         | DW              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74HC244NSR | SO           | NS              | 20   | 2000 | 346.0       | 346.0      | 41.0        |
| SN74HC244PWR | TSSOP        | PW              | 20   | 2000 | 346.0       | 346.0      | 33.0        |

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

## 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

#### FK (S-CQCC-N\*\*)

#### **28 TERMINAL SHOWN**

#### **LEADLESS CERAMIC CHIP CARRIER**



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



## PW (R-PDSO-G\*\*)

#### 14 PINS SHOWN

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

## **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



## W (R-GDFP-F20)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



## DW (R-PDSO-G20)

## PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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